

CHIP COIL (CHIP INDUCTOR) for Automotive infotainment/comfort equipment LQW15AN \(\subseteq 0.02 \subsete Murata Standard Reference Specification [AEC-Q200]

1. Scope

This reference specification applies to chip coil (chip inductor) LQW15AN_0Z series based on AEC-Q200.

1.1 Specific applications:

- Automotive infotainment/comfort equipment: Products that can be used for automotive equipment such as car navigation systems and car audio systems that do not directly relate to human life and whose structure, equipment, and performance are not specifically required by law to meet technical standards for safety assurance or environmental protection.
- Industrial equipment: Products that can be used in industrial equipment such as base stations, manufacturing equipment, industrial robotics equipment, and measurement equipment, and whose functions do not directly relate to the protection of human life and property.
- Medical equipment (GHTF Class C) *Except for implant/surgery/auto injector: Products that can be used for medical
 equipment of Class C of the international classification class GHTF and whose malfunction is considered to pose a
 relatively high risk to the human body.
- Medical equipment (GHTF Class A and B): Products that can be used for medical equipment regulated by Class A and Class B of the international classification class GHTF and whose functions do not directly relate to the protection of human life and property.
- Consumer equipment: Products that can be used in consumer equipment such as home appliances, audio/visual
 equipment, communication equipment, information equipment, office equipment, and household robotics, and whose
 functions are not directly related to the protection of human life and property.

This series is designed for use in Car Multimedia, Car Interior, Car Comfort application and General Electronic equipment. It is not appropriate for use in applications critical to passenger safety and car driving function (e.g. ABS, AIRBAG, etc.).

1.2 Unsuitable application:

Applications critical to passenger safety and car driving function (e.g. ABS, AIRBAG, etc.) and applications listed in "Limitation of applications" in this reference specification.

WE DISCLAIM ANY LOSS AND DAMAGES ARISING FROM OR IN CONNECTION WITH THE PRODUCTS INCLUDING BUT NOT LIMITED TO THE CASE SUCH LOSS AND DAMAGES CAUSED BY THE UNEXPECTED ACCIDENT, IN EVENT THAT THE PRODUCT IS APPLIED FOR THE PURPOSE WHICH IS SPECIFIED ABOVE AS THE UNSUITABLE APPLICATION FOR THE PRODUCT.

2. Part Numbering

(Ex.)									
LQ	W	15	A	N	1N5	В	0	Z	D
Product	Structure	Dimension	Application	Category	Inductance	Tolerance	Performance	Category	Packaging
ID		$(L \times W)$	and					Z: Automotive	D: taping
			characteristic						*B: bulk

^{*}B: Bulk packing is also available (taping condition: however, products without reels are put in plastic bags).

3. Part Number and Rating

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Ī	Operating temperature range	-55°C to +125°C
Ī	Storage temperature range	-55°C to +125°C

		Indu	ıctance		DC	Self-resonant	Rated	ESD
Customer Part number	Murata Part number	Nominal value (nH)	Tolerance	Q (Min.)	resistance (Ω max.)	frequency (GHz min.)	current (mA)	Rank 6: 25 kV
	LQW15AN1N5B0ZD	1.5	B: ±0.1 nH	10	0.03	18.0	1000	6
	LQW15AN1N5C0ZD	1.5	C: ±0.2 nH	10	0.03	18.0	1000	6
	LQW15AN1N5D0ZD	1.5	D: ±0.5 nH	10	0.03	18.0	1000	6
	LQW15AN1N6C0ZD	1.6	C: ±0.2 nH	10	0.07	17.0	750	6
	LQW15AN1N6D0ZD	1.6	D: ±0.5 nH	10	0.07	17.0	750	6
	LQW15AN1N7C0ZD	1.7	C: ±0.2 nH	10	0.10	17.0	640	6
	LQW15AN1N7D0ZD	1.7	D: ±0.5 nH	10	0.10	17.0	640	6
	LQW15AN1N8C0ZD	1.8	C: ±0.2 nH	10	0.16	16.0	460	6
	LQW15AN1N8D0ZD	1.8	D: ±0.5 nH	10	0.16	16.0	460	6
	LQW15AN2N4B0ZD	2.4	B: ±0.1 nH	20	0.05	15.0	850	6

		Indu	ıctance					
Customer	Murata	Nominal		Q	DC resistance	Self-resonant frequency	Rated current	ESD Rank
Part number	Part number	value (nH)	Tolerance	(Min.)	(Ω max.)	(GHz min.)	(mA)	6: 25 kV
	LQW15AN2N4C0ZD	2.4	C: ±0.2 nH	20	0.05	15.0	850	6
	LQW15AN2N4D0ZD	2.4	D: ±0.5 nH	20	0.05	15.0	850	6
	LQW15AN2N5B0ZD	2.5	B: ±0.1 nH	20	0.05	15.0	850	6
	LQW15AN2N5C0ZD	2.5	C: ±0.2 nH	20	0.05	15.0	850	6
	LQW15AN2N5D0ZD	2.5	D: ±0.5 nH	20	0.05	15.0	850	6
	LQW15AN2N6B0ZD	2.6	B: ±0.1 nH	20	0.05	15.0	850	6
	LQW15AN2N6C0ZD	2.6	C: ±0.2 nH	20	0.05	15.0	850	6
	LQW15AN2N6D0ZD	2.6	D: ±0.5 nH	20	0.05	15.0	850	6
	LQW15AN2N7B0ZD	2.7	B: ±0.1 nH	20	0.05	15.0	850	6
	LQW15AN2N7C0ZD	2.7	C: ±0.2 nH	20	0.05	15.0	850	6
	LQW15AN2N7D0ZD	2.7	D: ±0.5 nH	20	0.05	15.0	850	6
	LQW15AN2N8B0ZD	2.8	B: ±0.1 nH	20	0.05	15.0	850	6
	LQW15AN2N8C0ZD	2.8	C: ±0.2 nH	20	0.05	15.0	850	6
	LQW15AN2N8D0ZD	2.8	D: ±0.5 nH	20	0.05	15.0	850	6
	LQW15AN2N9B0ZD	2.9	B: ±0.1 nH	20	0.07	15.0	750	6
	LQW15AN2N9C0ZD	2.9	C: ±0.2 nH	20	0.07	15.0	750	6
	LQW15AN2N9D0ZD	2.9	D: ±0.5 nH	20	0.07	15.0	750	6
	LQW15AN3N0B0ZD	3.0	B: ±0.1 nH	20	0.07	15.0	750	6
	LQW15AN3N0C0ZD	3.0	C: ±0.2 nH	20	0.07	15.0	750	6
	LQW15AN3N0D0ZD	3.0	D: ±0.5 nH	20	0.07	15.0	750	6
	LQW15AN3N1B0ZD	3.1	B: ±0.1 nH	20	0.13	14.0	570	6
	LQW15AN3N1C0ZD	3.1	C: ±0.2 nH	20	0.13	14.0	570	6
	LQW15AN3N1D0ZD	3.1	D: ±0.5 nH	20	0.13	14.0	570	6
	LQW15AN3N2B0ZD	3.2	B: ±0.1 nH	15	0.17	14.0	500	6
	LQW15AN3N2C0ZD	3.2	C: ±0.2 nH	15	0.17	14.0	500	6
	LQW15AN3N2D0ZD	3.2	D: ±0.5 nH	15	0.17	14.0	500	6
	LQW15AN3N9B0ZD	3.9	B: ±0.1 nH	25	0.07	10.0	750	6
	LQW15AN3N9C0ZD	3.9	C: ±0.2 nH	25	0.07	10.0	750	6
	LQW15AN3N9D0ZD	3.9	D: ±0.5 nH	25	0.07	10.0	750	6
	LQW15AN4N1B0ZD	4.1	B: ±0.1 nH	25	0.07	10.0	750	6
	LQW15AN4N1C0ZD	4.1	C: ±0.2 nH	25	0.07	10.0	750	6
	LQW15AN4N1D0ZD	4.1	D: ±0.5 nH	25	0.07	10.0	750	6
	LQW15AN4N3B0ZD	4.3	B: ±0.1 nH	25	0.07	10.0	750	6
	LQW15AN4N3C0ZD	4.3	C: ±0.2 nH	25	0.07	10.0	750	6
	LQW15AN4N3D0ZD	4.3	D: ±0.5 nH	25	0.07	10.0	750	6
	LQW15AN4N4B0ZD	4.4	B: ±0.1 nH	25	0.07	8.0	750	6
	LQW15AN4N4C0ZD	4.4	C: ±0.2 nH	25	0.07	8.0	750	6
	LQW15AN4N4D0ZD	4.4	D: ±0.5 nH	25	0.07	8.0	750	6
	LQW15AN4N5B0ZD	4.5	B: ±0.1 nH	25	0.07	8.0	750	6
	LQW15AN4N5C0ZD	4.5	C: ±0.2 nH	25	0.07	8.0	750	6
	LQW15AN4N5D0ZD	4.5	D: ±0.5 nH	25	0.07	8.0	750	6
	LQW15AN4N6B0ZD	4.6	B: ±0.1 nH	25	0.07	8.0	750	6
	LQW15AN4N6C0ZD	4.6	C: ±0.2 nH	25	0.07	8.0	750	6
	LQW15AN4N6D0ZD	4.6	D: ±0.5 nH	25	0.07	8.0	750	6
	LQW15AN4N7B0ZD	4.7	B: ±0.1 nH	25	0.07	8.0	750	6
	LQW15AN4N7C0ZD	4.7	C: ±0.2 nH	25	0.07	8.0	750	6

		Indu	ıctance					
Customer	Murata	Nominal		Q	DC resistance	Self-resonant frequency	Rated current	ESD Rank
Part number	Part number	value	Tolerance	(Min.)	(Ω max.)	(GHz min.)	(mA)	6: 25 kV
	LQW15AN4N7D0ZD	(nH) 4.7	D: ±0.5 nH	25	0.07	8.0	750	6
	LQW15AN4N8B0ZD	4.8	B: ±0.1 nH	25	0.07	8.0	750	6
	LQW15AN4N8C0ZD	4.8	C: ±0.2 nH	25	0.07	8.0	750	6
	LQW15AN4N8D0ZD LQW15AN4N9B0ZD	4.8	D: ±0.5 nH	25	0.07	8.0	750	6
		4.9 4.9	B: ±0.1 nH	25 25	0.12 0.12	8.0	600	6
	LQW15AN4N9C0ZD LQW15AN4N9D0ZD		C: ±0.2 nH D: ±0.5 nH	25	0.12	8.0	600 600	6
	LQW15AN4N9D0ZD	4.9 5.0	B: ±0.5 nH	25	0.12	8.0	600	6
	LQW15AN5N0B0ZD					8.0		6
	LQW15AN5N0C0ZD	5.0 5.0	C: ±0.2 nH D: ±0.5 nH	25 25	0.12 0.12	8.0	600 600	
	LQW15AN5N0D0ZD	5.0		25	0.12	8.0	600	6
	LQW15AN5N1B0ZD	5.1	B: ±0.1 nH C: ±0.2 nH	25	0.12	8.0		6
	LQW15AN5N1C0ZD	5.1	D: ±0.5 nH	25 25	0.12	8.0	600 600	6
	LQW15AN5N1D0ZD	5.1	D: ±0.5 nH B: ±0.1 nH	25 25	0.12	8.0	700	6
	LQW15AN5N8B0ZD	5.8	C: ±0.1 nH	25 25	0.09	8.0	700	6
	LQW15AN5N8D0ZD	5.8	D: ±0.5 nH	25	0.09	8.0	700	6
	LQW15AN6N2B0ZD	6.2	B: ±0.5 nH	25			700	6
	LQW15AN6N2C0ZD	6.2	C: ±0.1 nH	25	0.09	8.0 8.0	700	6
	LQW15AN6N2C0ZD	6.2	D: ±0.5 nH		0.09			6
	LQW15AN6N3B0ZD	6.3	B: ±0.5 nH	25 25	0.09	8.0	700 700	6
	LQW15AN6N3B0ZD	6.3		25 25		6.0	700	6
	LQW15AN6N3C0ZD	6.3	C: ±0.2 nH D: ±0.5 nH	25	0.09	6.0	700	6
	LQW15AN6N3D0ZD	6.4		25				6
			B: ±0.1 nH C: ±0.2 nH	25	0.09	6.0	700	6
	LQW15AN6N4C0ZD LQW15AN6N4D0ZD	6.4 6.4	D: ±0.5 nH	25	0.09	6.0	700 700	6
	LQW15AN6N5B0ZD	6.5	B: ±0.3 nH	25	0.09	6.0	700	6
	LQW15AN6N5C0ZD	6.5	C: ±0.1 nH	25	0.09	6.0	700	6
	LQW15AN6N5D0ZD	6.5	D: ±0.5 nH	25	0.09	6.0	700	6
	LQW15AN6N6B0ZD	6.6	B: ±0.3 nH	25	0.09	6.0	700	6
	LQW15AN6N6C0ZD	6.6	C: ±0.1 nH	25	0.09	6.0	700	6
	LQW15AN6N6D0ZD	6.6	D: ±0.5 nH	25	0.09	6.0	700	6
	LQW15AN6N7B0ZD	6.7	B: ±0.1 nH	25	0.09	6.0	700	6
	LQW15AN6N7C0ZD	6.7	C: ±0.1 nH	25	0.09	6.0	700	6
	LQW15AN6N7D0ZD	6.7	D: ±0.5 nH	25	0.09	6.0	700	6
	LQW15AN6N8G0ZD	6.8	G: ±2%	25	0.09	6.0	700	6
	LQW15AN6N8H0ZD	6.8	H: ±3%	25	0.09	6.0	700	6
	LQW15AN6N8J0ZD	6.8	J: ±5%	25	0.09	6.0	700	6
	LQW15AN6N9G0ZD	6.9	G: ±2%	25	0.09	6.0	570	6
	LQW15AN6N9H0ZD	6.9	H: ±3%	25	0.13	6.0	570	6
	LQW15AN6N9J0ZD	6.9	J: ±5%	25	0.13	6.0	570	6
	LQW15AN7N0G0ZD	7.0	G: ±2%	25	0.13	6.0	570	6
	LQW15AN7N0H0ZD	7.0	H: ±3%	25	0.13	6.0	570	6
	LQW15AN7N0J0ZD	7.0	J: ±5%	25	0.13	6.0	570	6
	LQW15AN7N1G0ZD	7.1	G: ±2%	25	0.13	6.0	570	6
	LQW15AN7N1H0ZD	7.1	H: ±3%	25	0.13	6.0	570	6
	LQW15AN7N1J0ZD	7.1	J: ±5%	25	0.13	6.0	570	6
	FAM IOWINTINIONED	1.1	J. ±J70	20	0.13	0.0	310	U

		Indu	ctance					
Customer Murata	a N	lominal		Q	DC resistance	Self-resonant frequency	Rated current	ESD Rank
Part number Part num		value	Tolerance	(Min.)	(Ω max.)	(GHz min.)	(mA)	6: 25 kV
LQW15AN7N		(nH) 7.2	G: ±2%	25	0.13	6.0	570	6
LQW15AN7N		7.2	H: ±3%	25	0.13	6.0	570	6
LQW15AN7N		7.2	J: ±5%	25	0.13	6.0	570	6
LQW15AN7N		7.3	G: ±2%	25	0.13	6.0	570	6
LQW15AN7N		7.3	H: ±3%	25	0.13	6.0	570	6
LQW15AN7N		7.3	J: ±5%	25	0.13	6.0	570	6
LQW15AN7N		7.5	G: ±2%	25	0.13	6.0	570	6
LQW15AN7N		7.5	H: ±3%	25	0.13	6.0	570	6
LQW15AN7N		7.5	J: ±5%	25	0.13	6.0	570	6
LQW15AN8N		8.2	G: ±2%	25	0.13	5.5	540	6
LQW15AN8N		8.2	H: ±3%	25	0.14	5.5	540	6
LQW15AN8N		8.2	J: ±5%	25	0.14	5.5	540	6
LQW15AN8N		8.6	G: ±2%	25	0.14	5.5	540	6
LQW15AN8N		8.6	G. ±2% H: ±3%	25	0.14	5.5	540	6
LQW15AN8N		8.6	J: ±5%	25	0.14	5.5	540	6
LQW15AN8N		8.7	G: ±2%	25	0.14	5.5	540	6
LQW15AN8N		8.7	H: ±3%	25	0.14	5.5	540	6
LQW15AN8N		8.7	J: ±5%	25	0.14	5.5	540	6
LQW15AN8N		8.8	G: ±2%	25	0.14	5.5	540	6
LQW15AN8N		8.8	H: ±3%	25	0.14	5.5	540	6
LQW15AN8N		8.8	J: ±5%	25	0.14	5.5	540	6
LQW15AN8N		8.9	G: ±2%	25	0.14	5.5	540	6
LQW15AN8N		8.9	H: ±3%	25	0.14	5.5	540	6
LQW15AN8N		8.9	J: ±5%	25	0.14	5.5	540	6
LQW15AN9N		9.0	G: ±2%	25	0.14	5.5	540	6
LQW15AN9N		9.0	H: ±3%	25	0.14	5.5	540	6
LQW15AN9N		9.0	J: ±5%	25	0.14	5.5	540	6
LQW15AN9N		9.1	G: ±2%	25	0.14	5.5	540	6
LQW15AN9N		9.1	H: ±3%	25	0.14	5.5	540	6
LQW15AN9N		9.1	J: ±5%	25	0.14	5.5	540	6
LQW15AN9N		9.2	G: ±2%	25	0.14	5.5	540	6
LQW15AN9N		9.2	H: ±3%	25	0.14	5.5	540	6
LQW15AN9N		9.2	J: ±5%	25	0.14	5.5	540	6
LQW15AN9N		9.3	G: ±2%	25	0.14	5.5	540	6
LQW15AN9N		9.3	H: ±3%	25	0.14	5.5	540	6
LQW15AN9N		9.3	J: ±5%	25	0.14	5.5	540	6
LQW15AN9N		9.4	G: ±2%	25	0.14	5.5	540	6
LQW15AN9N		9.4	H: ±3%	25	0.14	5.5	540	6
LQW15AN9N		9.4	J: ±5%	25	0.14	5.5	540	6
LQW15AN9N		9.5	G: ±2%	25	0.14	5.5	540	6
LQW15AN9N		9.5	H: ±3%	25	0.14	5.5	540	6
LQW15AN9N		9.5	J: ±5%	25	0.14	5.5	540	6
LQW15AN9N		9.6	G: ±2%	25	0.14	5.5	540	6
LQW15AN9N		9.6	H: ±3%	25	0.14	5.5	540	6
LQW15AN9N		9.6	J: ±5%	25	0.14	5.5	540	6
LQW15AN9N		9.7	G: ±2%	25	0.14	5.5	540	6

		Indu	ıctance					
Customer	Murata	Nominal		Q	DC resistance	Self-resonant	Rated current	ESD Rank
Part number	Part number	value	Tolerance	(Min.)	(Ω max.)	frequency (GHz min.)	(mA)	6: 25 kV
	LOWASANONZUOZD	(nH)	11 00/	0.5	0.44		F40	0
	LQW15AN9N7H0ZD	9.7	H: ±3%	25	0.14	5.5	540	6
	LQW15AN9N7J0ZD	9.7	J: ±5%	25	0.14	5.5	540	6
	LQW15AN9N8G0ZD	9.8	G: ±2%	25	0.14	5.5	540	6
	LQW15AN9N8H0ZD	9.8	H: ±3%	25	0.14	5.5	540	6
	LQW15AN9N8J0ZD	9.8	J: ±5%	25	0.14	5.5	540	6
	LQW15AN9N9G0ZD	9.9	G: ±2%	25	0.14	5.5	540	6
	LQW15AN9N9H0ZD	9.9	H: ±3%	25	0.14	5.5	540	6
	LQW15AN9N9J0ZD	9.9	J: ±5%	25	0.14	5.5	540	6
	LQW15AN10NG0ZD	10	G: ±2%	25	0.17	5.5	500	6
	LQW15AN10NH0ZD	10	H: ±3%	25	0.17	5.5	500	6
	LQW15AN10NJ0ZD	10	J: ±5%	25	0.17	5.5	500	6
	LQW15AN11NG0ZD	11	G: ±2%	30	0.14	5.5	500	6
	LQW15AN11NH0ZD	11	H: ±3%	30	0.14	5.5	500	6
	LQW15AN11NJ0ZD	11	J: ±5%	30	0.14	5.5	500	6
	LQW15AN12NG0ZD	12	G: ±2%	30	0.14	5.5	500	6
	LQW15AN12NH0ZD	12	H: ±3%	30	0.14	5.5	500	6
	LQW15AN12NJ0ZD	12	J: ±5%	30	0.14	5.5	500	6
	LQW15AN13NG0ZD	13	G: ±2%	25	0.21	5.0	430	6
	LQW15AN13NH0ZD	13	H: ±3%	25	0.21	5.0	430	6
	LQW15AN13NJ0ZD	13	J: ±5%	25	0.21	5.0	430	6
	LQW15AN15NG0ZD	15	G: ±2%	30	0.16	5.0	460	6
	LQW15AN15NH0ZD	15	H: ±3%	30	0.16	5.0	460	6
	LQW15AN15NJ0ZD	15	J: ±5%	30	0.16	5.0	460	6
	LQW15AN16NG0ZD	16	G: ±2%	25	0.24	4.5	370	6
	LQW15AN16NH0ZD	16	H: ±3%	25	0.24	4.5	370	6
	LQW15AN16NJ0ZD	16	J: ±5%	25	0.24	4.5	370	6
	LQW15AN18NG0ZD	18	G: ±2%	25	0.27	4.5	370	6
	LQW15AN18NH0ZD	18	H: ±3%	25	0.27	4.5	370	6
	LQW15AN18NJ0ZD	18	J: ±5%	25	0.27	4.5	370	6
	LQW15AN19NG0ZD	19	G: ±2%	25	0.27	4.5	370	6
	LQW15AN19NH0ZD	19	H: ±3%	25	0.27	4.5	370	6
	LQW15AN19NJ0ZD	19	J: ±5%	25	0.27	4.5	370	6
	LQW15AN20NG0ZD	20	G: ±2%	25	0.27	4.0	370	6
	LQW15AN20NH0ZD	20	H: ±3%	25	0.27	4.0	370	6
	LQW15AN20NJ0ZD	20	J: ±5%	25	0.27	4.0	370	6
	LQW15AN22NG0ZD	22	G: ±2%	25	0.30	4.0	310	6
	LQW15AN22NH0ZD	22	H: ±3%	25	0.30	4.0	310	6
	LQW15AN22NJ0ZD	22	J: ±5%	25	0.30	4.0	310	6
	LQW15AN23NG0ZD	23	G: ±2%	25	0.30	3.8	310	6
	LQW15AN23NH0ZD	23	H: ±3%	25	0.30	3.8	310	6
	LQW15AN23NJ0ZD	23	J: ±5%	25	0.30	3.8	310	6
	LQW15AN24NG0ZD	24	G: ±2%	25	0.52	3.5	280	6
	LQW15AN24NH0ZD	24	H: ±3%	25	0.52	3.5	280	6
	LQW15AN24NJ0ZD	24	J: ±5%	25	0.52	3.5	280	6
	LQW15AN27NG0ZD	27	G: ±2%	25	0.52	3.5	280	6
	LQW15AN27NH0ZD	27	H: ±3%	25	0.52	3.5	280	6

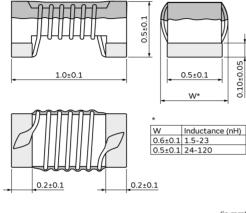
		Inductance			DC	0.15	Detect	ECD
Customer	Murata	Nominal		Q	DC resistance	Self-resonant frequency	Rated current	ESD Rank
Part number	Part number	value (nH)	Tolerance	(Min.)	(Ω max.)	(GHz min.)	(mA)	6: 25 kV
	LQW15AN27NJ0ZD	27	J: ±5%	25	0.52	3.5	280	6
	LQW15AN30NG0ZD	30	G: ±2%	25	0.58	3.3	270	6
	LQW15AN30NH0ZD	30	H: ±3%	25	0.58	3.3	270	6
	LQW15AN30NJ0ZD	30	J: ±5%	25	0.58	3.3	270	6
	LQW15AN33NG0ZD	33	G: ±2%	25	0.63	3.2	260	6
	LQW15AN33NH0ZD	33	H: ±3%	25	0.63	3.2	260	6
_	LQW15AN33NJ0ZD	33	J: ±5%	25	0.63	3.2	260	6
	LQW15AN36NG0ZD	36	G: ±2%	25	0.63	3.1	260	6
	LQW15AN36NH0ZD	36	H: ±3%	25	0.63	3.1	260	6
	LQW15AN36NJ0ZD	36	J: ±5%	25	0.63	3.1	260	6
	LQW15AN39NG0ZD	39	G: ±2%	25	0.70	3.0	250	6
	LQW15AN39NH0ZD	39	H: ±3%	25	0.70	3.0	250	6
	LQW15AN39NJ0ZD	39	J: ±5%	25	0.70	3.0	250	6
	LQW15AN40NG0ZD	40	G: ±2%	25	0.70	3.0	250	6
	LQW15AN40NH0ZD	40	H: ±3%	25	0.70	3.0	250	6
	LQW15AN40NJ0ZD	40	J: ±5%	25	0.70	3.0	250	6
	LQW15AN43NG0ZD	43	G: ±2%	25	0.70	3.0	250	6
	LQW15AN43NH0ZD	43	H: ±3%	25	0.70	3.0	250	6
	LQW15AN43NJ0ZD	43	J: ±5%	25	0.70	3.0	250	6
	LQW15AN47NG0ZD	47	G: ±2%	25	1.08	2.9	210	6
	LQW15AN47NH0ZD	47	H: ±3%	25	1.08	2.9	210	6
	LQW15AN47NJ0ZD	47	J: ±5%	25	1.08	2.9	210	6
	LQW15AN51NG0ZD	51	G: ±2%	25	1.08	2.85	210	6
	LQW15AN51NH0ZD	51	H: ±3%	25	1.08	2.85	210	6
	LQW15AN51NJ0ZD	51	J: ±5%	25	1.08	2.85	210	6
	LQW15AN56NG0ZD	56	G: ±2%	25	1.17	2.8	200	6
	LQW15AN56NH0ZD	56	H: ±3%	25	1.17	2.8	200	6
	LQW15AN56NJ0ZD	56	J: ±5%	25	1.17	2.8	200	6
	LQW15AN62NG0ZD	62	G: ±2%	20	1.82	2.6	145	6
	LQW15AN62NH0ZD	62	H: ±3%	20	1.82	2.6	145	6
	LQW15AN62NJ0ZD	62	J: ±5%	20	1.82	2.6	145	6
	LQW15AN68NG0ZD	68	G: ±2%	20	1.96	2.5	140	6
	LQW15AN68NJ0ZD	68	J: ±5%	20	1.96	2.5	140	6
	LQW15AN72NG0ZD	72	G: ±2%	20	2.10	2.5	135	6
	LQW15AN72NJ0ZD	72	J: ±5%	20	2.10	2.5	135	6
	LQW15AN75NG0ZD	75	G: ±2%	20	2.10	2.4	135	6
	LQW15AN75NJ0ZD	75	J: ±5%	20	2.10	2.4	135	6
	LQW15AN82NG0ZD	82	G: ±2%	20	2.24	2.3	130	6
	LQW15AN82NJ0ZD	82	J: ±5%	20	2.24	2.3	130	6
	LQW15AN91NG0ZD	91	G: ±2%	20	2.38	2.1	125	6
	LQW15AN91NJ0ZD	91	J: ±5%	20	2.38	2.1	125	6
	LQW15ANR10J0ZD	100	J: ±5%	20	2.52	1.5	120	6
	LQW15ANR12J0ZD	120	J: ±5%	20	2.66	1.0	110	6



4. Testing Conditions

Temperature: ordinary temperature (15°C to 35°C) Humidity: ordinary humidity [25% to 85% (RH)]
Temperature: 20°C±2°C Humidity: 60% to 70% (RH) Atmospheric pressure: 86 kPa to 106 kPa

5. Appearance and Dimensions



(in mm)

Unit mass (typical value): 0.0008 g

6. Marking

No marking.



7. Electrical Performance

No.	Item	Specification		Test method
7.1	Inductance	Meet chapter 3 ratings.	Measuring equipme equivalent Measuring frequence Inductance	nt: Keysight E4991A or the y: 100 MHz 250 MHz
				150 MHz 72 nH to 120 nH
			Measurement terr Electrical length: Measuring fixture: K Position the chip coi	nal level: Approx. 0 dBm minal distance: 0.5 mm 10.0 mm (eysight 16197A il under test as shown in the below and connect it to the g weight.
7.2	Q	Meet chapter 3 ratings.	- Measurement exam	pie.
			0 0	Product
				see "Electrical performance: for inductance/Q" in the chapter
7.3	DC resistance	Meet chapter 3 ratings.	Measuring equipme	nt: digital multimeter
7.4	Self-resonant frequency	Meet chapter 3 ratings.	Measuring equipme equivalent	nt: Keysight N5230A or the
7.5	Rated current	Product temperature rise: 20°C max.	Apply the rated curr	ent specified in chapter 3.

8. AEC-Q200 Requirement

8.1 Performance [based on table 5 for magnetics (inductors/transformer) AEC-Q200 Rev. D issued June 1, 2010]

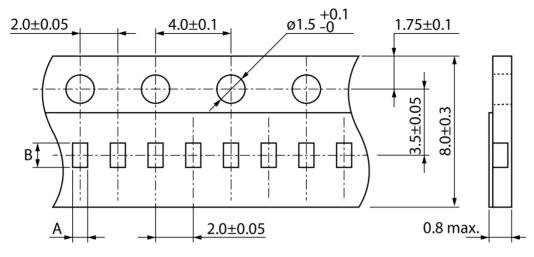
		AEC-Q200	- Murata specification/deviation		
No.	Stress	Test method			
3	High temperature exposure	1000 h at 125°C Set for 24 h at room condition, then measured.		eet table A after testing. Table A Appearance Inductance change rate (at 100 MHz)	No damage Within ±5%
4	Temperature cycling	1000 cycles -40°C to +125°C Set for 24 h at room condition, then measured.	M	eet table A after testing.	
7	Biased humidity	1000 h at 85°C, 85% (RH). Unpowered. Set for 24 h at room condition, then measured.	M	eet table A after testing.	
8	Operational life	Apply 125°C 1000 h Set for 24 h at room condition, then measured.	M	eet table A after testing.	
9	External visual	Visual inspection	No	o abnormalities	

		AEC-Q200	Murata appaification/deviation				
No.	Stress	Test method	Murata specification/deviation				
10	Physical dimension	Meet chapter 5, "Appearance and Dimensions".	No defects				
12	Resistance to solvents	Per MIL-STD-202 Method 215	Not applicable				
13	Mechanical shock	Per MIL-STD-202 Method 213 Condition C: 100 g's (0.98 N), 6 ms, half sine, 12.3 ft/s	Meet table A after testing.				
14	Vibration	5 g's (0.049 N) for 20 min, 12 cycles each of 3 orientations Test from 10 Hz to 2000 Hz	Meet table A after testing.				
15	Resistance to soldering heat	No-heating Solder temperature 260°C±5°C Immersion time 10 s	Pre-heating: 150°C±10°C, 60 s to 90 s Meet table A after testing.				
17	ESD	Per AEC-Q200-002	ESD rank: Refer to chapter 3 ratings. Meet table A after testing.				
18	Solderbility	Per J-STD-002	Method b: not applicable 95% of the terminations is to be soldered (except exposed wire).				
19	Electrical characterization	Measured: inductance	No defects				
20	Flammability	Per UL-94	Not applicable				
21	Board flex	Epoxy-PCB (1.6 mm) Deflection 2 mm (min.)	Meet table B after testing. Table B				
		Holding time 60 s	Appearance No damage				
			DC resistance change rate Within ±10%				
22	Terminal strength	Per AEC-Q200-006 A force of 17.7 N for 60 s	No defects Murata deviation request: 5 N for 60 s				



9. Specification of Packaging

9.1 Appearance and dimensions of tape (8 mm width/paper tape)



Direction of Feed

(in mm)

Inductance	A* (mm) (Dimensional tolerance ±0.03)	B* (mm) (Dimensional tolerance ±0.03)
1N5, 2N4 to 2N8, 3N9 to 4N8, 5N8 to 6N8, 8N2 to 9N9, 11N, 12N, 15N	0.69	1.18
1N6 to 1N8, 2N9, 3N0, 3N1, 3N2, 4N9 to 5N1, 6N9 to 7N5, 10N, 13N, 16N to 23N, R10, R12	0.66	1.18
24N to 91N	0.64	1.18

^{*}Typical value

9.2 Taping specifications

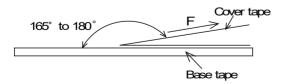
Packing quantity (Standard quantity)	10000 pcs/reel
Packing method	The products are placed in embossed cavities of a base tape and sealed by a cover tape.
Feed hole position	The feed holes on the base tape are on the right side when the cover tape is pulled toward the user.
Joint	The base tape and the cover tape are seamless.
Number of missing products	Number of missing products within 0.025% of the number per reel or 1 pc., whichever is greater, and are not continuous. The specified quantity per reel is kept.

9.3 Break down force of tape

Break down force of cover tape	5 N min.
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9.4 Peeling off force of cover tape

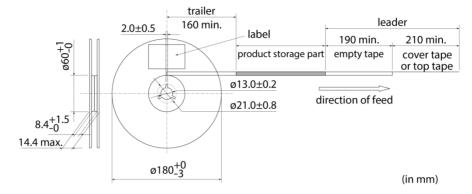
Speed of peeling off	300 mm/min
Peeling off force	0.1 N to 0.6 N (The lower limit is for typical value.)





9.5 Dimensions of leader section, trailer section and reel

A vacant section is provided in the leader (start) section and trailer (end) section of the tape for the product. The leader section is further provided with an area consisting only of the cover tape (or top tape). (See the diagram below.)



9.6 Marking for reel

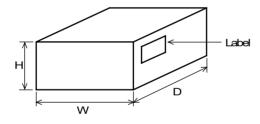
Customer part number. Murata part number, inspection number (*1), RoHS marking (*2), quantity, etc.

-	Sustainer part number, warata part number, inspection number (1), Norto marking (2), quantity, etc.			
	*1 Expression of inspection No.:			(1) Factory code (2) Date
	(1)	(2)	(3)	First digit: year/last digit of year
	()	,	()	Second digit: month/Jan. to Sep.→1 to 9, Oct. to Dec.→O, N, D Third, Fourth digit: day (3) Serial No.
	*2 Expression of RoHS marking: ROHS- $\frac{Y}{(1)}$ $\frac{(\triangle)}{(2)}$		(△)	(1) RoHS regulation conformity (2) Murata classification number

9.7 Marking on outer box (corrugated box)

Customer name, purchasing order number, customer part number, Murata part number, RoHS marking (*2), quantity, etc.

9.8 Specification of outer box



Dimensions of outer box (mm)		Standard reel quantity in outer box (reel)	
W D H		in outer box (reei)	
186 186 93		93	5
* Above outer box size is typical. It depends on a			



10. ACaution

10.1 Limitation of applications

The products listed in the reference specification (hereinafter the product(s) is called as the "Product(s)") are designed and manufactured for applications specified in the reference specification (hereinafter called as the "Specific Application"). We shall not warrant anything in connection with the Products including fitness, performance, adequateness, safety, or quality, in the case of applications listed in from (1) to (11) written at the end of this precautions, which may generally require high performance, function, quality, management of production or safety. Therefore, the Product shall be applied in compliance with the specific application.

WE DISCLAIM ANY LOSS AND DAMAGES ARISING FROM OR IN CONNECTION WITH THE PRODUCTS INCLUDING BUT NOT LIMITED TO THE CASE SUCH LOSS AND DAMAGES CAUSED BY THE UNEXPECTED ACCIDENT, IN EVENT THAT (i) THE PRODUCT IS APPLIED FOR THE PURPOSE WHICH IS NOT SPECIFIED AS THE SPECIFIC APPLICATION FOR THE PRODUCT, AND/OR (ii) THE PRODUCT IS APPLIED FOR ANY FOLLOWING APPLICATION PURPOSES FROM (1) TO (11) (EXCEPT THAT SUCH APPLICATION PURPOSE IS UNAMBIGUOUSLY SPECIFIED AS SPECIFIC APPLICATION FOR THE PRODUCT IN OUR CATALOG SPECIFICATION FORMS, DATASHEETS, OR OTHER DOCUMENTS OFFICIALLY ISSUED BY US*).

- (1) Aircraft equipment
- (2) Aerospace equipment
- (3) Undersea equipment
- (4) Power plant control equipment
- (5) Medical equipment
- (6) Transportation equipment
- (7) Traffic control equipment
- (8) Disaster prevention/security equipment
- (9) Industrial data-processing equipment
- (10) Combustion/explosion control equipment
- (11) Equipment with complexity and/or required reliability equivalent to the applications listed in the above.

For exploring information of the Products which will be compatible with the particular purpose other than those specified in the reference specification, please contact our sales offices, distribution agents, or trading companies with which you make a deal, or via our web contact form.

Contact form: https://www.murata.com/contactform

* We may design and manufacture particular Products for applications listed in (1) to (11). Provided that, in such case we shall unambiguously specify such Specific Application in the reference specification without any exception. Therefore, any other documents and/or performances, whether exist or non-exist, shall not be deemed as the evidence to imply that we accept the applications listed in (1) to (11).

10.2 Precautions on rating

Avoid using in exceeded the rated temperature range, rated voltage, or rated current.

Usage when the ratings are exceeded could lead to wire breakage, burning, or other serious fault.

10.3 Inrush current

If an inrush current (or pulse current or rush current) that significantly exceeds the rated current is applied to the product, overheating could occur, resulting in wire breakage, burning, or other serious fault.

10.4 Fail-safe

Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

10.5 Corrosive gas

Please refrain from use since contact with environments with corrosive gases (sulfur gas [hydrogen sulfide, sulfur dioxide, etc.], chlorine, ammonia, etc.) or oils (cutting oil, silicone oil, etc.) that have come into contact with the previously stated corrosive gas environment will result in deterioration of product quality or an open from deterioration due to corrosion of product electrode, etc. We will not bear any responsibility for use under these environments.



11. Precautions for Use

This product is for use only with reflow soldering. It is designed to be mounted by soldering. If you want to use other mounting method, for example, using a conductive adhesive, please consult us beforehand.

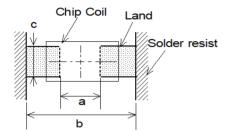
Also, if repeatedly subjected to temperature cycles or other thermal stress, due to the difference in the coefficient of thermal expansion with the mounting substrate, the solder (solder fillet part) in the mounting part may crack.

The occurrence of cracks due to thermal stress is affected by the size of the land where mounted, the solder volume, and the heat dissipation of the mounting substrate. Carefully design it when a large change in ambient temperature is assumed.

11.1 Land dimensions

The following diagram shows the recommended land dimensions for reflow soldering.

The land dimensions are designed in consideration of electrical characteristics and mountability. Use of other land dimensions may preclude achievement of performance. In some cases, it may result in poor solderability, including positional shift. If you use other land pattern, consider it adequately.



а	0.50	
b	1.2	
С	0.65	
	(in mr	m)

11.2 Flux and solder used

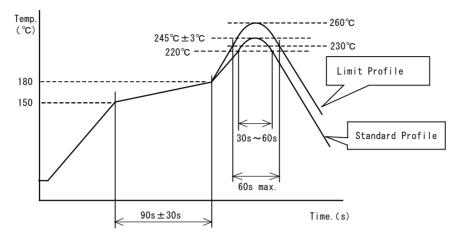
 Use a rosin-based flux that includes an activator with a chlorine conversion value of 0.06 mass% to 0.1 mass%. Do not use a highly acidic flux with a halide content exceeding 0.2 mass% (chlorine conversion value). Do not use a water-soluble flux.
 Use Sn-3.0Ag-0.5Cu solder. Standard thickness of solder paste: 100 μm to 150 μm

If you want to use a flux other than the above, please consult our technical department.



11.3 Soldering conditions (reflow)

- Pre-heating should be in such a way that the temperature difference between solder and product surface is limited to 150°C max.
 - Cooling into solvent after soldering also should be in such a way that the temperature difference is limited to 100°C max. Insufficient pre-heating may cause cracks on the product, resulting in the deterioration of product quality.
- Standard soldering profile and the limit soldering profile is as follows. The excessive limit soldering conditions may cause leaching of the electrode and/or resulting in the deterioration of product quality.



	Standard profile	Limit profile
Pre-heating	150°C to 180°C/90 s±30 s	150°C to 180°C/90 s±30 s
Heating	Above 220°C/30 s to 60 s	Above 230°C/60 s max.
Peak temperature	245°C±3°C	260°C/10 s
Number of reflow cycles	2 times	2 times

11.4 Reworking with soldering iron

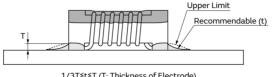
The following requirements must be met to rework a soldered product using a soldering iron.

Item	Requirement
Pre-heating	150°C/approx. 1 min
Tip temperature of soldering iron	350°C max.
Power consumption of soldering iron	80 W max.
Tip diameter of soldering iron	ø3 mm max.
Soldering time	3 s (+1 s, -0 s)
Number of reworking operations	2 times max.
<u> </u>	

Avoid a direct contact of the tip of the soldering iron with the product. Such a direction contact may cause cracks in the ceramic body due to thermal shock.

11.5 Solder volume

Solder shall be used not to increase the volume too much.



1/3T≦t≦T (T: Thickness of Electrode)

An increased solder volume increases mechanical stress on the product. Exceeding solder volume may cause the failure of mechanical or electrical performance.

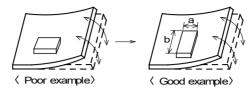


11.6 Product's location

The following shall be considered when designing and laying out PCBs.

(1) PCB shall be designed so that products are not subject to mechanical stress due to warping the board. [Products direction]

Products shall be located in the sideways direction (length: a < b) to the mechanical stress.



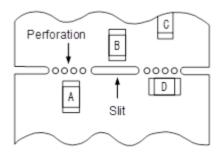
(2) Components location on PCB separation

It is effective to implement the following measures, to reduce stress in separating the board.

It is best to implement all of the following three measures; however, implement as many measures as possible to reduce

Contents of measures	Stress level	
(1) Turn the mounting direction of the component parallel to the board separation surface.	A > D*1	
(2) Add slits in the board separation part.	A > B	
(3) Keep the mounting position of the component away from the board separation surface.	A > C	
*1 A > D is valid when stress is added vertically to the perforation as with hand separation.		

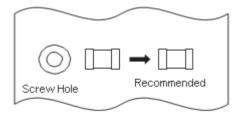
If a cutting disc is used, stress will be diagonal to the PCB, therefore A > D is invalid.



(3) Mounting components near screw holes

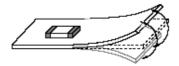
When a component is mounted near a screw hole, it may be affected by the board deflection that occurs during the tightening of the screw.

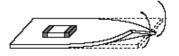
Mount the component in a position as far away from the screw holes as possible.



11.7 Handling of substrate

After mounting products on a substrate, do not apply any stress to the product caused by bending or twisting to the substrate when cropping the substrate, inserting and removing a connector from the substrate or tightening screw to the substrate. Excessive mechanical stress may cause cracking in the product.





Bending

Twisting



11.8 Cleaning

The product shall be cleaned under the following conditions.

- (1) The cleaning temperature shall be 60°C max. If isopropyl alcohol (IPA) is used, the cleaning temperature shall be 40°C max.
- (2) Perform ultrasonic cleaning under the following conditions. Exercise caution to prevent resonance phenomenon in mounted products and the PCB.

Item	Requirement	
Power	20 W/L max.	
Time	5 min max.	
Frequency	28 kHz to 40 kHz	

(3) Cleaner

Alcohol-based cleaner: IPA

Aqueous agent: PINE ALPHA ST-100S

- (4) There shall be no residual flux or residual cleaner. When using aqueous agent, rinse the product with deionized water adequately and completely dry it so that no cleaner is left.
- * For other cleaning, consult our technical department.

11.9 Storage and transportation

Storage period	Use the product within 12 months after delivery. If you do not use the product for more than 12 months, check solderability before using it.
Storage conditions	 The products shall be stored in a room not subject to rapid changes in temperature and humidity. The recommended temperature range is -10°C to +40°C. The recommended relative humidity range is 15% to 85%. Keeping the product in corrosive gases, such as sulfur, chlorine gas or acid may cause the poor solderability. Do not place the products directly on the floor; they should be placed on a palette so that they are not affected by humidity or dust. Avoid keeping the products in a place exposed to direct sunlight, heat or vibration. Do not keep products in bulk packaging. Bulk storage could result in collisions between the products or between the products and other parts, resulting in chipping or wire breakage. Avoid storing the product by itself bare (i.e. exposed directly to air).
Transportation	Excessive vibration and impact reduces the reliability of the products. Exercise caution when handling the products.

11.10 Resin coating (including moisture-proof coating)

When the product is coated/molded with resin, its electrical characteristics may change.

A wire breakage issue may occur by mechanical stress caused by the resin, amount/cured shape of resin, or operating condition etc.

Some resins contain impurities or hydrolyzable chlorine, which could result in corrosion of the conducting materials, leading to wire breakage.

So, please pay your careful attention when you select resin in case of coating/molding the products with the resin.

Prior to use the coating resin, please make sure no reliability issue is observed by evaluating products mounted on your board.

11.11 Mounting conditions

Check the mounting condition before using.

Using mounting conditions (nozzles, equipment conditions, etc.) that are not suitable for products may lead to pick up errors, misalignment, or damage to the product.

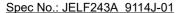
With some types of mounting equipment, a support pin pushes up the product from the bottom of the base (paper) tape when the product is sucked with the pick-up nozzle. When using this type of equipment, detach the support pin to prevent the breaking of wire on the product.

In some cases, the laser recognition function of the mounting equipment may not recognize this product correctly. Please contact us when using laser recognition. (There is no problem with the permeation and reflection type.)

11.12 Operating environment

Do not use this product under the following environmental conditions as it may cause deterioration of product quality.

- (1) In the corrodible atmosphere such as acidic gases, alkaline gases, chlorine, sulfur gases, organic gases and etc. (the sea breeze, Cl2, H2S, NH3, SO2, NO2, etc)
- (2) In the atmosphere where liquid such as organic solvent, may splash on the products.
- (3) In the atmosphere where the temperature/humidity changes rapidly and it is easy to dew.





11.13 Mounting density

If this product is placed near heat-generating products, be sure to implement sufficient heat-dissipating measures. If this product is subjected to a significant amount of heat from other products, this could adversely affect product quality, resulting in a circuit malfunction or failure of the mounted section. Also, be sure that the product is used in a manner so that the heat that the product is subjected to from other products does not exceed the upper limit of the rated operating temperature for the product.

11.14 Handling of product

- To prevent wire breakage, sharp objects such as tweezers, bristles of cleaning brushes, and other objects must not contact the winding section or the electrode section.
- Mechanical shock should not be applied to the products mounted on the board to prevent the breaking of the core.

12. **Note**

- (1) Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- (2) You are requested not to use our product deviating from the reference specifications.
- (3) The contents of this reference specification are subject to change without advance notice. Please approve our product specifications or transact the approval sheet for product specifications before ordering.

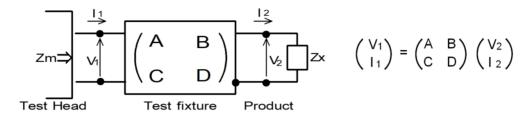


13. Appendix

Electrical performance: Measuring method for inductance/Q (Q measurement is applicable only when the Q value is included in the rating table.)

Perform measurement using the method described below. (Perform correction for the error deriving from the measuring terminal.)

(1) Residual elements and stray elements of the measuring terminal can be expressed by the F parameter for the 2-pole terminal as shown in the figure below.



(2) The product's impedance value (Zx) and measured impedance value (Zm) can be expressed as shown below, by using the respective current and voltage for input/output.

$$Zm = \frac{V_1}{I_1} \qquad Zx = \frac{V_2}{I_2}$$

(3) Thus, the relationship between the product's impedance value (Zx) and measured impedance value (Zm) is as follows.

	Here,
	$\alpha = D/A = 1$
	β = B/D = Zsm - (1 - Yom Zsm) Zss
$Z_{X}=\alpha \frac{Z_{M}-\beta}{1-Z_{M}\Gamma}$	Γ = C/A = Yom
	Zsm: measured impedance of short chip
	Zss: residual impedance of short chip (0.556 nH)
	Yom: measured admittance when measuring terminal is open

(4) Calculate inductance Lx and Qx using the equations shown below.

$Lx = \frac{Im (Zx)}{2\pi f}$ $Im (Zx)$	Lx: inductance of chip coil Qx: Q of chip coil
$Qx = \frac{m(Zx)}{Re(Zx)}$	f: measuring frequency